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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET



cmos integrated circuit $\mu PD5716GR$

CMOS MMIC 4 x 2 IF SWITCH MATRIX

FEATURES

· 4 independent IF channels, integral switching to channel input to either channel output

· Integrated 4 bit decoder

Frequency range : f = 250 to 2 150 MHz
 High isolation D/U ratio : ISL = 29 dB TYP.

• Insertion loss : Lins = 6.7 dB TYP. @ Z_0 = 50 Ω

Insertion loss flatness : △LINS = 0.7 dB TYP.
 Control voltage : VCONT = 0 V/+5.0 V

• 16-pin plastic HTSSOP package

APPLICATIONS

· DBS IF switching

Switch box

• 4 × 2 switching application for microwave signal

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPD5716GR-E1	μPD5716GR-E1-A	16-pin plastic HTSSOP (Pb-Free)		 Embossed tape 12 mm wide Pin 8, 9 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: µPD5716GR

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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ABSOLUTE MAXIMUM RATINGS (Ta = +25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V _{DD}	+6.0	V
Switch Control Voltage 1 to 4	VCONT1 to 4	+6.0	٧
Total Power Dissipation	Ptot	2 Note	W
Input Power	Pin	+15	dBm
Operating Ambient Temperature	TA	-40 to +85	°C
Storage Temperature	Tstg	-65 to +150	°C

Note Mounted on double-sided copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB, T_A = +85°C

RECOMMENDED OPERATING CONDITIONS (TA = +25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V _{DD}	+4.0	+5.0	+5.5	٧
Control Voltage (H) Note	VCONT (H)	+4.0	+5.0	+5.5	٧
Control Voltage (L)	VCONT (L)	-0.2	0	+0.4	٧

Note V_{DD} -0.4 $V \le V_{CONT (H)} \le V_{DD}$ +0.2 V

ELECTRICAL CHARACTERISTICS (TA = +25°C, VDD = +5.0 V, VCONT = 0 V/+5.0 V, Pin = 0 dBm, Zo = 50Ω , each port, unless otherwise specified)

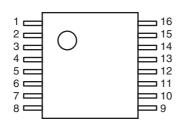
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss	Lins	f = 0.25 to 2.15 GHz	-	6.7	9.0	dB
Insertion Loss Flatness	⊿Lins	LINS (0.95 GHz) — LINS (2.15 GHz)	_	0.7	3.0	dB
Isolation D/U-ratio1 Note 1	ISL1	f = 0.25 to 0.95 GHz	28	35	_	dB
Isolation D/U-ratio2 Note 1	ISL2	f = 0.95 to 2.15 GHz	25	29	_	dB
Output Return Loss	RLout	f = 0.25 to 2.15 GHz	10	13	_	dB
Control Current Note 2	Ісонт	V _{DD} = +5.0 V, V _{CONT} = +5.0 V/0 V, non-RF	-	50	100	μΑ
Supply Current	loo	V _{DD} = +5.0 V, V _{CONT} = +5.0 V/0 V, non-RF	_	50	100	μΑ

Notes 1. Isolation Desire Un-desire (D/U)-ratio = | (Signal leakage (off-state)) – (Insertion loss (on-state))|

2. Per 1 control pin

PIN CONNECTIONS

(Top View)



Pin No.	Pin Name	Pin No.	Pin Name
1	IN-C	16	IN-B
2	GND	15	GND
3	IN-D	14	IN-A
4	GND	13	GND
5	GND	12	V _{DD}
6	OUT2	11	OUT1
7	Vсонт3	10	Vcont1
8	Vcont4	9	Vcont2

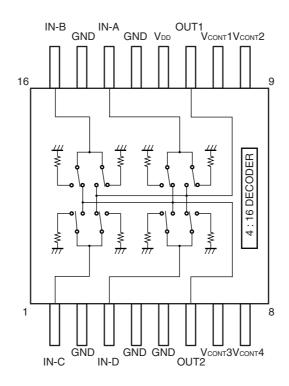
Remark Back side. : GND

TRUTH TABLE

State		Output Signal		Control Pins			
No.	Mode	OUT1	OUT2	Vcont1	Vcont2	Vcонт3	Vcont4
1	AA	IN-A	IN-A	Low	Low	Low	Low
2	AB		IN-B	Low	Low	Low	High
3	AC		IN-C	Low	Low	High	Low
4	AD		IN-D	Low	Low	High	High
5	ВА	IN-B	IN-A	Low	High	Low	Low
6	BB		IN-B	Low	High	Low	High
7	ВС		IN-C	Low	High	High	Low
8	BD		IN-D	Low	High	High	High
9	CA	IN-C	IN-A	High	Low	Low	Low
10	СВ		IN-B	High	Low	Low	High
11	СС		IN-C	High	Low	High	Low
12	CD		IN-D	High	Low	High	High
13	DA	IN-D	IN-A	High	High	Low	Low
14	DB		IN-B	High	High	Low	High
15	DC		IN-C	High	High	High	Low
16	DD		IN-D	High	High	High	High

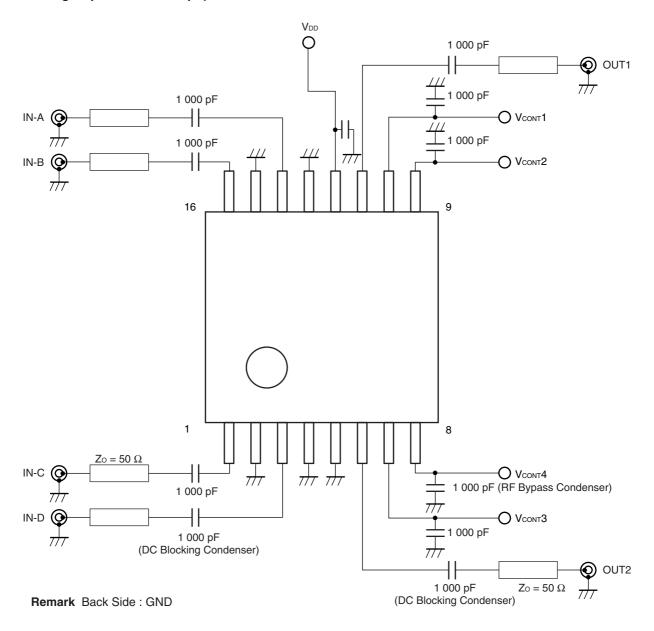
Remark High: +5.0 Vdc, Low: 0 Vdc

FUNCTIONAL DIAGRAM



Remark Back Side : GND

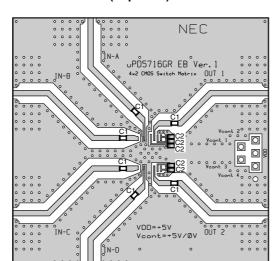
EVALUATION CIRCUIT (VDD = +5.0 V, VCONT1 to VCONT4 = 0 V/+5.0 V, Pin = 0 dBm, Zo = 50 Ω , DC Blocking Capacitor = 1 000 pF)



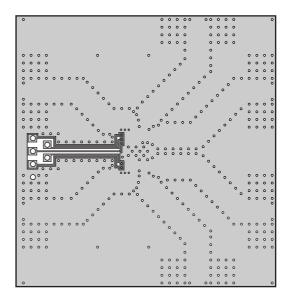
The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

(Top View)



(Bottom View)



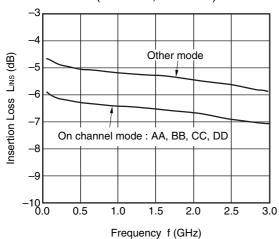
Notes

- 1. $50 \times 53 \times 0.51$ mm double sided copper clad RO4003 (Rogers) board ($\varepsilon r = 3.38$).
- 2. Au plated on pattern
- 3. oO: Through holes
- 4. C1, C2: 1 000 pF

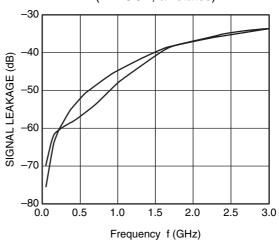
TYPICAL CHARACTERISTICS

(TA = +25°C, VDD = +5.0 V, VCONT = 0 V/+5.0 V, Pin = 0 dBm, Zo = 50 Ω , unless otherwise specified)

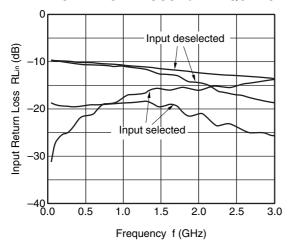
INSERTION LOSS vs. FREQUENCY (INx-OUT, all states)



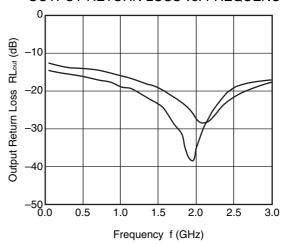
SIGNAL LEAKAGE vs. FREQUENCY (INx-OUT, all states)



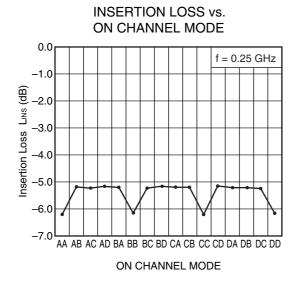
INPUT RETURN LOSS vs. FREQUENCY

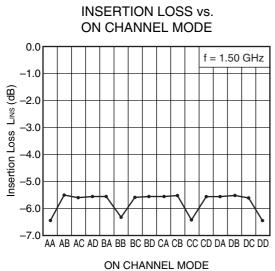


OUTPUT RETURN LOSS vs. FREQUENCY

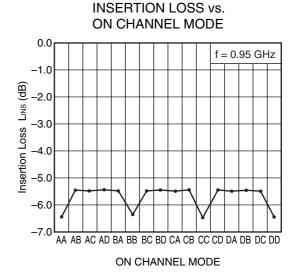


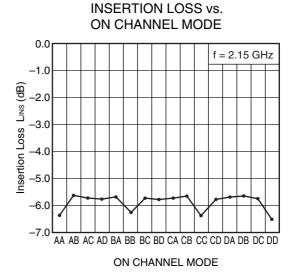
Remark The graphs indicate nominal characteristics.





Remark The graphs indicate nominal characteristics.





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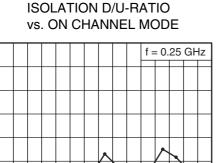
-20

-30

-60

-80

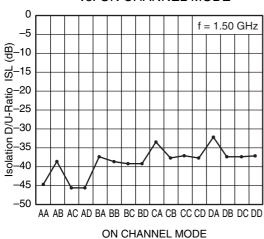
Isolation D/U-Ratio ISL (dB)



ON CHANNEL MODE

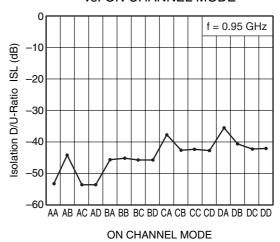
AA AB AC AD BA BB BC BD CA CB CC CD DA DB DC DD

ISOLATION D/U-RATIO vs. ON CHANNEL MODE

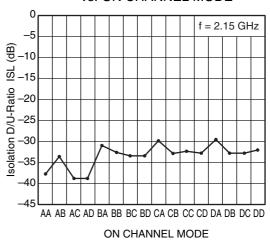


Remark The graphs indicate nominal characteristics.

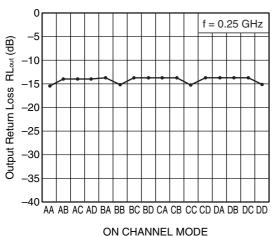
ISOLATION D/U-RATIO vs. ON CHANNEL MODE



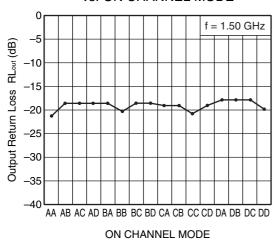
ISOLATION D/U-RATIO vs. ON CHANNEL MODE



OUTPUT RETURN LOSS vs. ON CHANNEL MODE

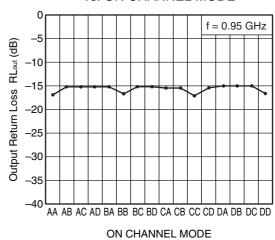


OUTPUT RETURN LOSS vs. ON CHANNEL MODE

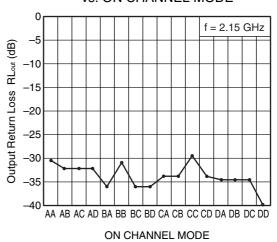


Remark The graphs indicate nominal characteristics.

OUTPUT RETURN LOSS vs. ON CHANNEL MODE



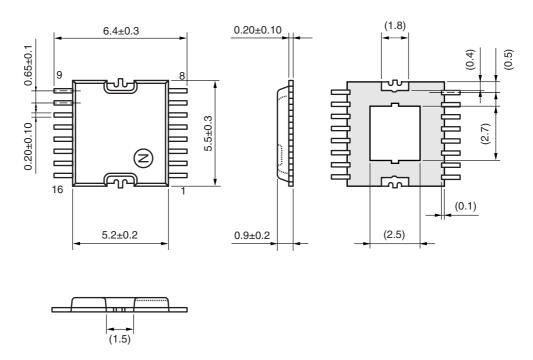
OUTPUT RETURN LOSS vs. ON CHANNEL MODE



10

PACKAGE DIMENSIONS

16-PIN PLASTIC HTSSOP (UNIT: mm)



Remark (): Reference value

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

12

NEC μ PD5716GR

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NEC Compound Semiconductor Devices Hong Kong Limited

E-mail: contact@ncsd-hk.necel.com

Hong Kong Head Office TEL: +852-3107-7303 FAX: +852-3107-7309
Taipei Branch Office TEL: +886-2-8712-0478 FAX: +886-2-2545-3859
Korea Branch Office TEL: +82-2-558-2120 FAX: +82-2-558-5209

NEC Electronics (Europe) GmbH http://www.eu.necel.com/

TEL: +49-211-6503-0 FAX: +49-211-6503-1327

California Eastern Laboratories, Inc. http://www.cel.com/

TEL: +1-408-988-3500 FAX: +1-408-988-0279

Compound Semiconductor Devices Division NEC Electronics Corporation URL: http://www.ncsd.necel.com/